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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/760,464	01/21/2004	Paul Rich	WLJ.099	1392
	7590 02/16/200 FRANCOS, & WHITT	EXAMINER		
ONE FREEDOM SQUARE 11951 FREEDOM DRIVE SUITE 1260			MCDONALD, RODNEY GLENN	
RESTON, VA		00	ART UNIT	PAPER NUMBER
,			1753	
SHORTENED STATUTOR	Y PERIOD OF RESPONSE	MAIL DATE	DELIVER	Y-MODE
3 MONTHS		02/16/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

	Application No.	Applicant(s)			
•	10/760,464	RICH ET AL.			
Office Action Summary	Examiner	Art Unit			
	Rodney G. McDonald	1753			
The MAILING DATE of this communica Period for Reply	tion appears on the cover sheet wit	th the correspondence address			
A SHORTENED STATUTORY PERIOD FOR WHICHEVER IS LONGER, FROM THE MAIL - Extensions of time may be available under the provisions of 3 after SIX (6) MONTHS from the mailing date of this communic - If NO period for reply is specified above, the maximum statute - Failure to reply within the set or extended period for reply will, Any reply received by the Office later than three months after earned patent term adjustment. See 37 CFR 1.704(b).	LING DATE OF THIS COMMUNIC 17 CFR 1.136(a). In no event, however, may a recation. by period will apply and will expire SIX (6) MONT by statute, cause the application to become ABA	CATION. pply be timely filed THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed of	on				
2a)☐ This action is FINAL . 2b)	☐ This action is non-final.				
3) Since this application is in condition for	his application is in condition for allowance except for formal matters, prosecution as to the merits is				
closed in accordance with the practice	under <i>Ex parte Quayle</i> , 1935 C.D.	. 11, 453 O.G. 213.			
Disposition of Claims	•				
4)⊠ Claim(s) <u>1-8</u> is/are pending in the application	cation				
4a) Of the above claim(s) is/are v					
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>1-8</u> is/are rejected.		•			
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction	n and/or election requirement.				
Application Papers					
9) The specification is objected to by the E	Vaminer				
10) The drawing(s) filed on is/are: a		ov the Examiner.			
Applicant may not request that any objection					
Replacement drawing sheet(s) including the					
11) The oath or declaration is objected to by					
Priority under 35 U.S.C. § 119	Construction and add to the OF HOO.	440(-) (-) (5)			
12) Acknowledgment is made of a claim for	foreign priority under 35 U.S.C. §	119(a)-(d) or (f).			
a) All b) Some * c) None of:	eumanta haya baan raasiyad				
1. Certified copies of the priority do		polication No			
	cuments have been received in Ap the priority documents have been i				
application from the International		received in this National Stage			
* See the attached detailed Office action for		received			
occ the attached detailed office details.	si a not or the continue copies not i	000,700.			
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Attachment(s) 1) Notice of References Cited (PTO-892)	A) □ 1=1==±=== 0.	ummary (PTO-413)			
2) Notice of Preferences Cited (P10-892) Notice of Draftsperson's Patent Drawing Review (PTO-	·)/Mail Date			

U.S. Patent and Trademark Office PTOL-326 (Rev. 08-06)

3) Information Disclosure Statement(s) (PTO/SB/08)
Paper No(s)/Mail Date 1/04, 6/04, 9/05.

5) Notice of Informal Patent Application
6) Other: _____.

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DETAILED ACTION

Claim Rejections - 35 USC § 112

Claim 8 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claim 8 is indefinite because "A method" lacks antecedent basis in claim 2. Should this claim depend from claim 7?

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claims 1-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Weichart et al. (US PGPUB 2003/0075522 A1) in view of Francis (U.S. Pat. 6,465,353).

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Regarding claim 1, Weichart et al. teach an apparatus for processing a substrate wafer including a chamber 1. (Page 4 paragraph 0044) A plasma creation element 2 for creating a plasma in a zone of the chamber. (Page 2 paragraph 0022) An electrostatic chuck for retaining a substrate at a substrate location in or adjacent to the zone. (Page 4 paragraph 0041) The apparatus includes a dark space shield 5b circumjacent the periphery of the location for preventing the presence of the plasma between the shield and the periphery of a substrate in the location whilst allowing processing of the substrate. (Page 4 paragraph 0041; paragraph 0043)

Regarding claim 2, Weichart et al. describes the shield 5b as generally annular. (Page 4 paragraph 0041)

Regarding claim 3, Weichart et al. describe the shield 5b as electrically conducting. (Page 4 paragraph 0041, paragraph 0043)

Regarding claim 4, Weichart et al. teach that the shield 5b is grounded. (Page 4 paragraph 0043)

Regarding claim 5, Weichart et al. teach that the chuck is also a plasma creating element. (Page 4 paragraph 0042, paragraph 0043)

Regarding claim 6, Weichart et al. teach that the chuck is powered. (Page 4 paragraph 0042, paragraph 0043)

Regarding claim 7, Weichart et al. teach a method for processing a wafer. (Page 4 paragraph 0046) Including electrostatically clamping the substrate to the chuck.

(Page 4 paragraph 0041) Creating a plasma adjacent to the outwardly facing face of the clamped substrate and locating a dark space shield between the plasma and the

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periphery of the substrate to prevent the presence of plasma between the shield and the periphery whilst allowing processing of the substrate. (Page 2 paragraph 0022; Page 4 paragraph 0045)

The differences between Weichart et al. and the present claims is that the thickness of the wafer substrate is not discussed (Claims 1,7 and 8)

Regarding the thickness of the wafer in claims 1, 7 and 8, Francis teach that semiconductor devices need thin wafers for processing. The thickness can be about 100 microns or less. (Column 1 lines 13-26, lines 39-60; Column 2 lines 38-42)

The motivation for utilizing the feature of Francis is that it allows processing wafers for semiconductor dies. (Column 1 lines 39-40)

Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to have modified Weichart et al. by utilizing the feature of Francis because it allows for processing wafers for semiconductor dies.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Rodney G. McDonald whose telephone number is 571-272-1340. The examiner can normally be reached on M-Th with Every other Friday off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nam X. Nguyen can be reached on 571-272-1342. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Rodney G. McDonald

Primary Examiner

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RM

January 8, 2007